



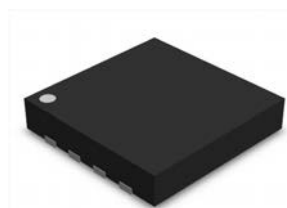
JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD.

DFNWB3×3-8L Plastic-Encapsulate MOSFETS

CJAE2002 Dual N-Channel MOSFET

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
18V	4.4 mΩ@4.5V	15A
	4.5 mΩ@4.0V	
	4.6 mΩ@3.8V	
	4.9 mΩ@3.1V	
	5.4 mΩ@2.5V	

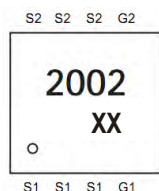
DFNWB3×3-8L



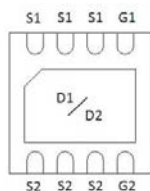
DESCRIPTION

The CJAE2002 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It is ESD protected. This device is suitable for use as a uni-directional or bi-directional load switch, facilitated by its common-drain configuration.

MARKING:



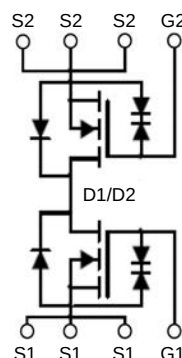
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2002 = Part No.
Solid dot = Pin1 indicator.
XX = Code.

Equivalent Circuit



MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	18	V
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	$I_D^{①}$	15	A
	$T_A = 70^\circ\text{C}$		13	
	$T_C = 25^\circ\text{C}$		55	
	$T_C = 100^\circ\text{C}$		35	
Pulsed Drain Current		$I_{DM}^{①②}$	100	A
Thermal Resistance from Junction to Ambient		$R_{\theta JA}$	42	$^\circ\text{C/W}$
Thermal Resistance from Junction to Case		$R_{\theta JC}$	3	$^\circ\text{C/W}$
Total Power Dissipation		$P_D^{③}$	3	W
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55~+150	$^\circ\text{C}$

MOSFET ELECTRICAL CHARACTERISTICS

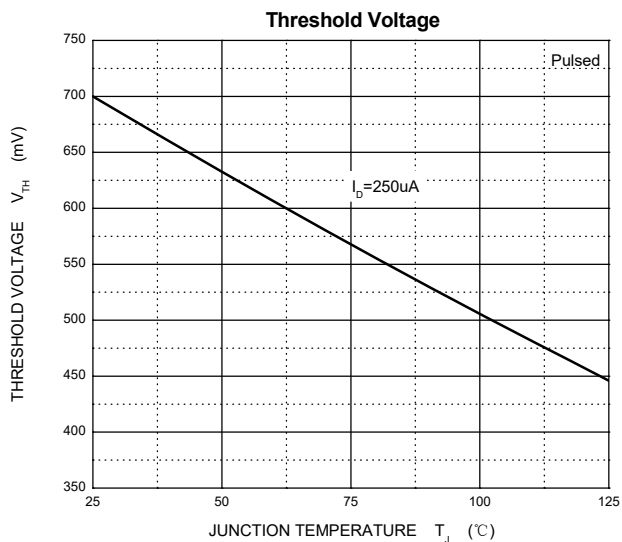
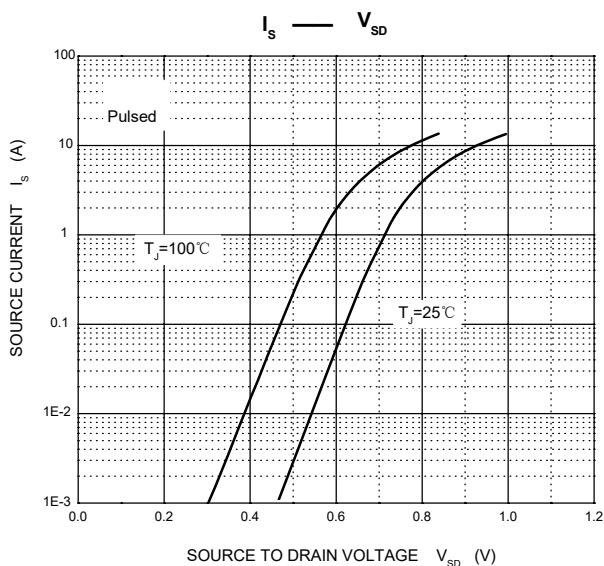
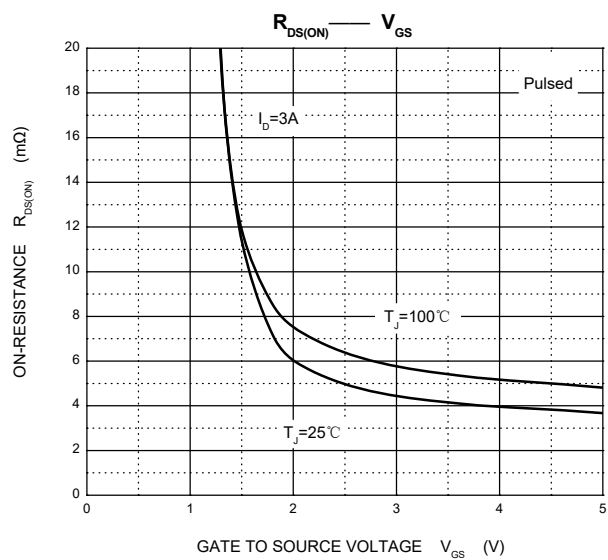
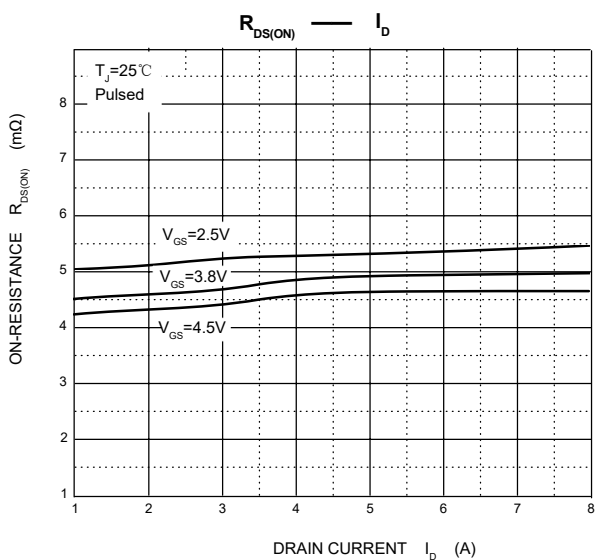
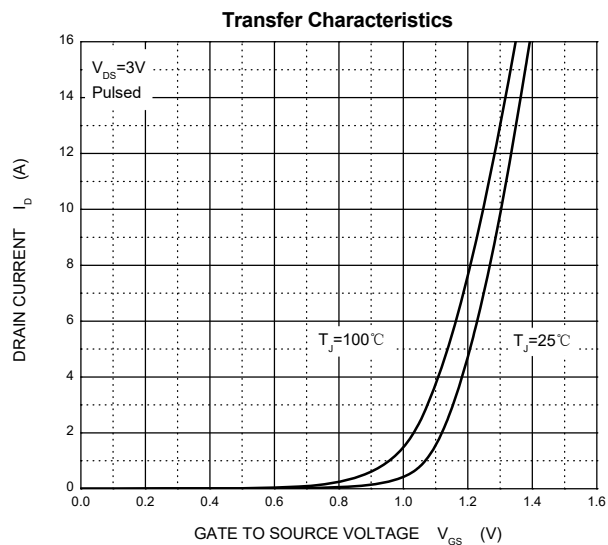
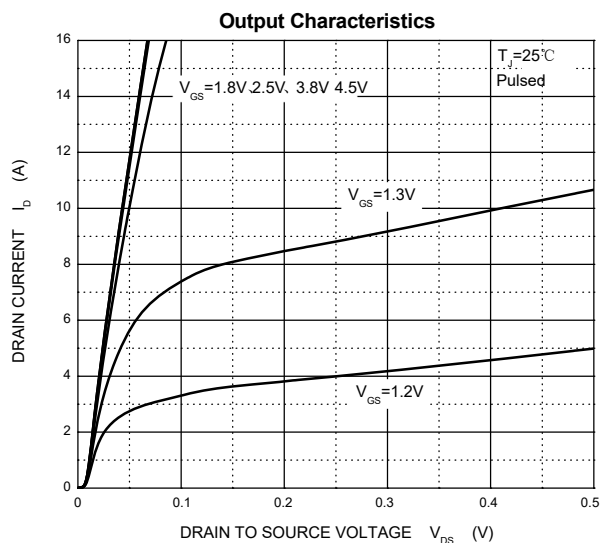
$T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	18			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 16V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 4.5V, V_{DS} = 0V$			± 1	μA
		$V_{GS} = \pm 8V, V_{DS} = 0V$			± 10	μA
On characteristics ^④						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.4		1	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 3A$	4.0	4.4	5.5	m Ω
		$V_{GS} = 4.0V, I_D = 3A$	4.1	4.5	5.8	m Ω
		$V_{GS} = 3.8V, I_D = 3A$	4.2	4.6	6.0	m Ω
		$V_{GS} = 3.1V, I_D = 3A$	4.4	4.9	6.3	m Ω
		$V_{GS} = 2.5V, I_D = 3A$	4.8	5.4	6.5	m Ω
Forward tranconductance	g_{FS}	$V_{DS} = 5V, I_D = 3A$	8	42		S
DYNAMIC PARAMETERS ^⑤						
Input Capacitance	C_{iss}	$V_{DS} = 10V, V_{GS} = 0V, f = 1MHz$		1970		pF
Output Capacitance	C_{oss}			315		pF
Reverse Transfer Capacitance	C_{rss}			285		pF
Switching characteristics ^⑤						
Total gate charge	Q_g	$V_{DS} = 10V, V_{GS} = 4.5V, I_D = 3A$		26.5		nC
Gate-source charge	Q_{gs}			2.4		nC
Gate-drain charge	Q_{gd}			7.6		nC
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 5V, V_{DD} = 10V, I_D = 3A$ $R_L = 1.35\Omega, R_{GEN} = 3\Omega$		4.5		ns
Turn-on rise time	t_r			8.9		ns
Turn-off delay time	$t_{d(off)}$			85		ns
Turn-off fall time	t_f			24		ns
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	V_{SD} ^④	$V_{GS} = 0V, I_S = 1A$			1.0	V
Continuous drain-source diode forward current	I_S ^①				55	A
Pulsed drain-source diode forward current	I_{SM} ^{①②}				100	A

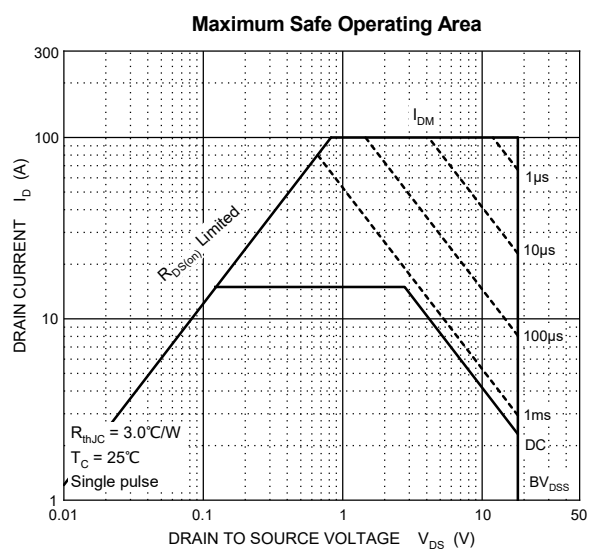
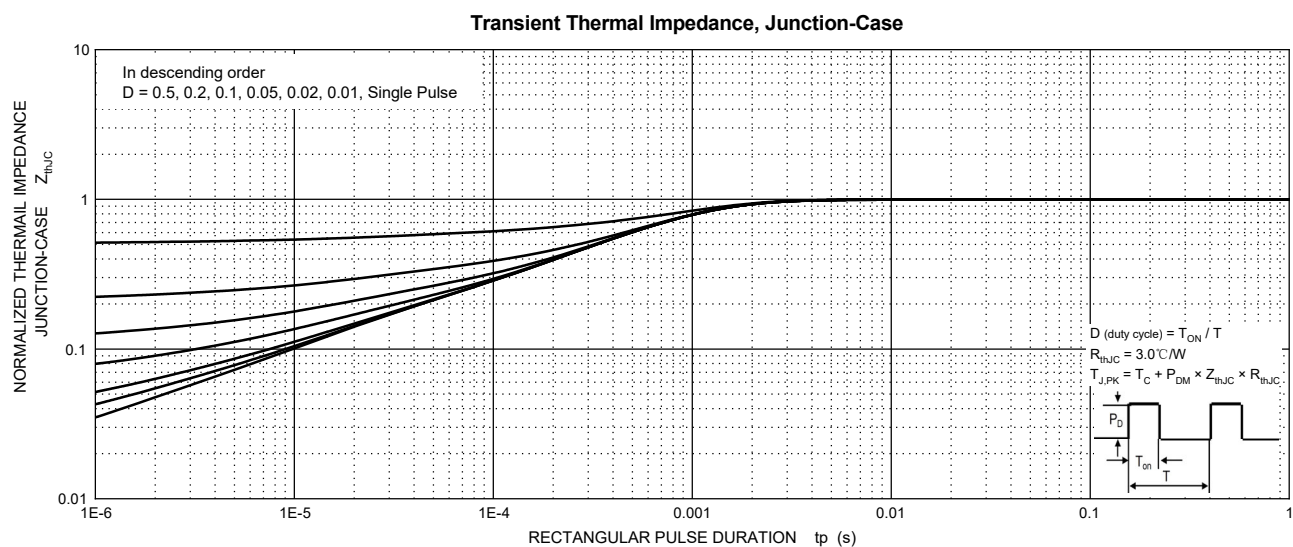
Notes :

1. The data tested by surface mounted on a 1 inch²FR-4 board with 2OZ copper.
2. Pulse Test:Pulse Width < 10us, Duty Cycle < 0.5%.
3. The power dissipation is limited by 150 $^\circ\text{C}$ junction temperature
4. Pulse Test : Pulse width $\leq 300\mu s$, duty cycle $\leq 0.5\%$.
5. Guaranteed by design, not subject to production testing.
6. The data is theoretically the same as I_D , in real applications , should be limited by total power dissipation.

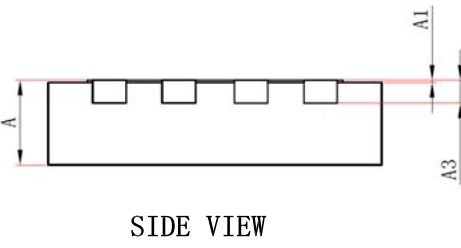
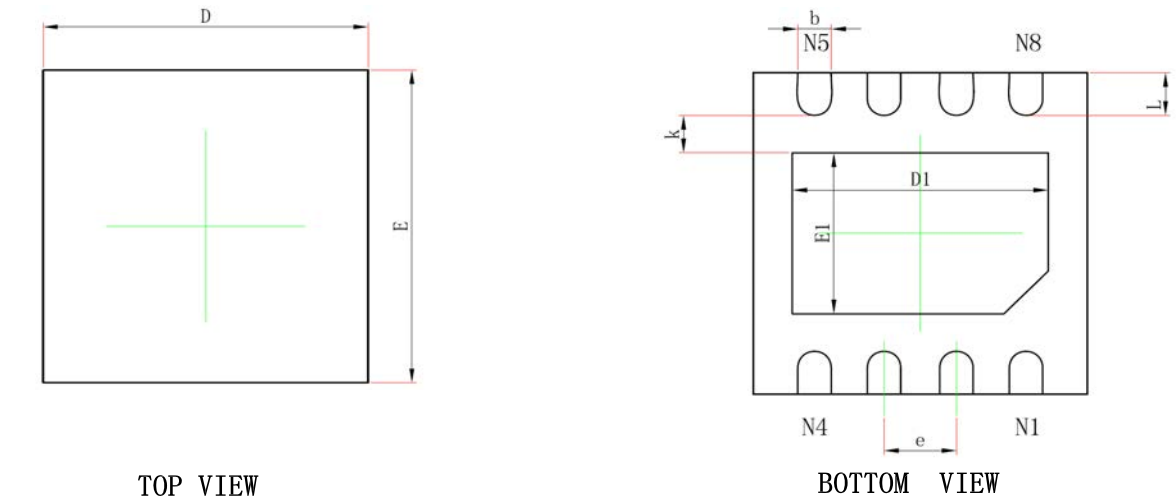
Typical Characteristics



Typical Characteristics

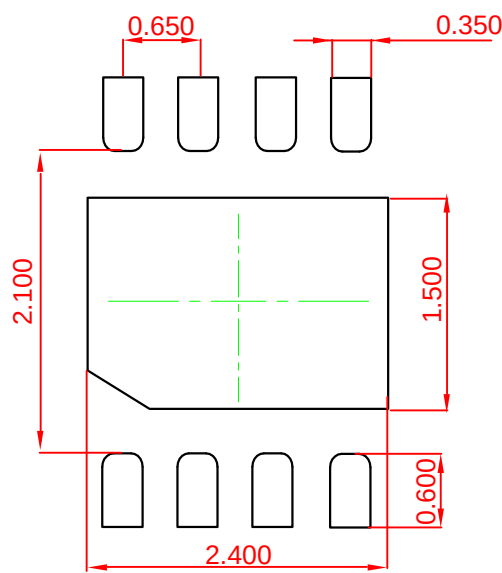


DFNWB3×3-8L-J Package Outline Dimensions(Unit:mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	2.924	3.076	0.115	0.121
E	2.924	3.076	0.115	0.121
D1	2.200	2.400	0.087	0.094
E1	1.400	1.600	0.055	0.063
b	0.250	0.350	0.010	0.014
k	0.200MIN		0.008MIN	
e	0.650TYP.		0.026TYP.	
L	0.324	0.476	0.013	0.019

DFNWB3×3-8L Suggested Pad Layout



Note:
1.Controlling dimension:in millimeters.
2.General tolerance:± 0.050mm.
3.The pad layout is for reference purposes only.

NOTICE

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